

$V_{DRM} = 4500 \text{ V}$
 $I_{TGQM} = 2000 \text{ A}$
 $I_{TSM} = 13 \text{ kA}$
 $V_{T0} = 1.80 \text{ V}$
 $r_T = 0.85 \text{ m}\Omega$
 $V_{DClin} = 2200 \text{ V}$

Gate turn-off Thyristor

5SGA 20H4502

Doc. No. 5SYA 1210-01 Aug. 2000

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

Authorized Distributor:
Darrah Electric Company
www.darrahelectric.com

Blocking

| | | | |
|--------------|---|-----------------------|---|
| V_{DRM} | Repetitive peak off-state voltage | 4500 V | $V_{GR} \geq 2V$ |
| V_{RRM} | Repetitive peak reverse voltage | 17 V | |
| I_{DRM} | Repetitive peak off-state current | $\leq 100 \text{ mA}$ | $V_D = V_{DRM}$ $V_{GR} \geq 2V$ |
| I_{RRM} | Repetitive peak reverse current | $\leq 50 \text{ mA}$ | $V_R = V_{RRM}$ $R_{GK} = \infty$ |
| V_{DClink} | Permanent DC voltage for 100 FIT failure rate | 2200 V | $-40 \leq T_j \leq 125 \text{ }^\circ\text{C}$. Ambient cosmic radiation at sea level in open air. |

Mechanical data (see Fig. 19)

| | | | | |
|-------|---|--------|-----|----------------|
| F_m | Mounting force | min. | 17 | kN |
| | | max. | 24 | kN |
| A | Acceleration: Device unclamped Device clamped | | 50 | m/s^2 |
| | | | 200 | m/s^2 |
| M | Weight | | 0.8 | kg |
| D_s | Surface creepage distance | \geq | 22 | mm |
| D_a | Air strike distance | \geq | 13 | mm |

Darrah Electric Company
5914 Merrill Avenue
Cleveland, Ohio 44102 USA
216-631-0912
216-631-0440 fax
www.darrahelectric.com



GTO Data**On-state**

| | | | | |
|------------|--|--------------------------------------|--|--|
| I_{TAVM} | Max. average on-state current | 710 A | Half sine wave, $T_C = 85\text{ }^\circ\text{C}$ | |
| I_{TRMS} | Max. RMS on-state current | 1115 A | | |
| I_{TSM} | Max. peak non-repetitive surge current | 13 kA | $t_P = 10\text{ ms}$ | $T_j = 125\text{ }^\circ\text{C}$ After surge: $V_D = V_R = 0\text{V}$ |
| | | 24 kA | $t_P = 1\text{ ms}$ | |
| I^2t | Limiting load integral | $0.85 \cdot 10^6\text{ A}^2\text{s}$ | $t_P = 10\text{ ms}$ | |
| | | $0.29 \cdot 10^6\text{ A}^2\text{s}$ | $t_P = 1\text{ ms}$ | |
| V_T | On-state voltage | 3.50 V | $I_T = 2000\text{ A}$ | $T_j = 125\text{ }^\circ\text{C}$ |
| V_{T0} | Threshold voltage | 1.80 V | $I_T = 400 - 3000\text{ A}$ | |
| r_T | Slope resistance | 0.85 m Ω | | |
| I_H | Holding current | 50 A | $T_j = 25\text{ }^\circ\text{C}$ | |

Gate

| | | | | |
|-----------|---------------------------------|-------|---------------------------|----------------------------------|
| V_{GT} | Gate trigger voltage | 1.0 V | $V_D = 24\text{ V}$ | $T_j = 25\text{ }^\circ\text{C}$ |
| I_{GT} | Gate trigger current | 2.5 A | $R_A = 0.1\text{ }\Omega$ | |
| V_{GRM} | Repetitive peak reverse voltage | 17 V | | |
| I_{GRM} | Repetitive peak reverse current | 50 mA | $V_{GR} = V_{GRM}$ | |

Turn-on switching

| | | | | |
|----------------|---------------------------------------|----------------------|------------------------------|---|
| di/dt_{crit} | Max. rate of rise of on-state current | 400 A/ μs | $f = 200\text{ Hz}$ | $I_T = 2000\text{ A}, T_j = 125\text{ }^\circ\text{C}$ $I_{GM} = 30\text{ A}, di_G/dt = 20\text{ A}/\mu\text{s}$ |
| | | 600 A/ μs | $f = 1\text{ Hz}$ | |
| t_d | Delay time | 2.0 μs | $V_D = 0.5 V_{DRM}$ | $T_j = 125\text{ }^\circ\text{C}$ |
| t_r | Rise time | 6.0 μs | $I_T = 2000\text{ A}$ | $di/dt = 200\text{ A}/\mu\text{s}$ |
| $t_{on(min)}$ | Min. on-time | 80 μs | $I_{GM} = 30\text{ A}$ | $di_G/dt = 20\text{ A}/\mu\text{s}$ |
| E_{on} | Turn-on energy per pulse | 2.50 Ws | $C_S = 4\text{ }\mu\text{F}$ | $R_S = 5\text{ }\Omega$ |

Turn-off switching

| | | | | |
|----------------|-----------------------------------|--------------------|-----------------------------------|--|
| I_{TGQM} | Max controllable turn-off current | 2000 A | $V_{DM} = V_{DRM}$ | $di_{GQ}/dt = 30\text{ A}/\mu\text{s}$ |
| | | | $C_S = 4\text{ }\mu\text{F}$ | $L_S \leq 0.3\text{ }\mu\text{H}$ |
| t_s | Storage time | 22.0 μs | $V_D = \frac{1}{2} V_{DRM}$ | $V_{DM} = V_{DRM}$ |
| t_f | Fall time | 3.0 μs | $T_j = 125\text{ }^\circ\text{C}$ | $di_{GQ}/dt = 30\text{ A}/\mu\text{s}$ |
| $t_{off(min)}$ | Min. off-time | 80 μs | $I_{TGQ} = I_{TGQM}$ | |
| E_{off} | Turn-off energy per pulse | 7.5 Ws | $C_S = 4\text{ }\mu\text{F}$ | $R_S = 5\text{ }\Omega$ |
| I_{GQM} | Peak turn-off gate current | 725 A | $L_S \leq 0.3\text{ }\mu\text{H}$ | |

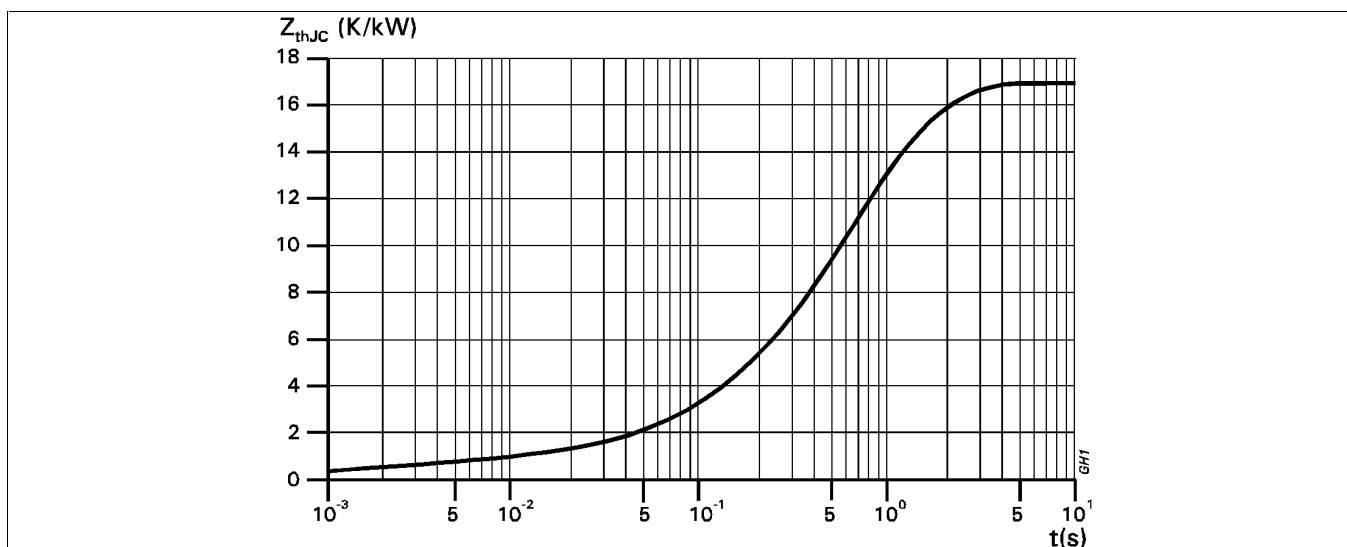
Thermal

| | | | |
|------------|--|-------------|---------------------|
| T_j | Storage and operating junction temperature range | -40...125°C | |
| R_{thJC} | Thermal resistance junction to case | 30 K/kW | Anode side cooled |
| | | 39 K/kW | Cathode side cooled |
| | | 17 K/kW | Double side cooled |
| R_{thCH} | Thermal resistance case to heat sink | 10 K/kW | Single side cooled |
| | | 5 K/kW | Double side cooled |

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^4 R_i (1 - e^{-t/\tau_i})$$

| i | 1 | 2 | 3 | 4 |
|--------------|------|------|-------|--------|
| R_i (K/kW) | 11.7 | 4.7 | 0.64 | 0.0001 |
| τ_i (s) | 0.9 | 0.26 | 0.002 | 0.001 |

**Fig. 1** Transient thermal impedance, junction to case.

Darrah Electric Company
 5914 Merrill Avenue
 Cleveland, Ohio 44102 USA
 216-631-0912
 216-631-0440 fax
www.darrahelectric.com



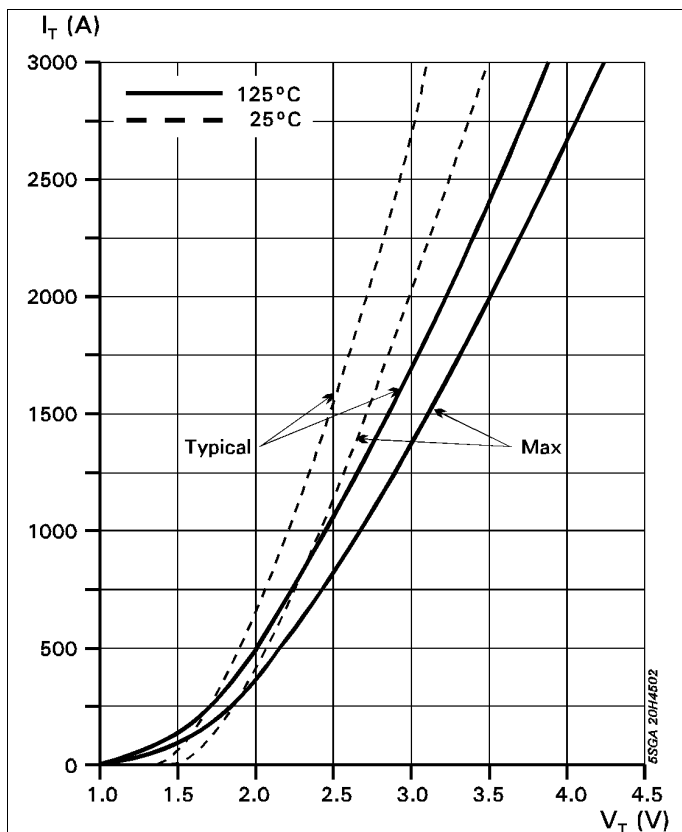


Fig. 2 On-state characteristics

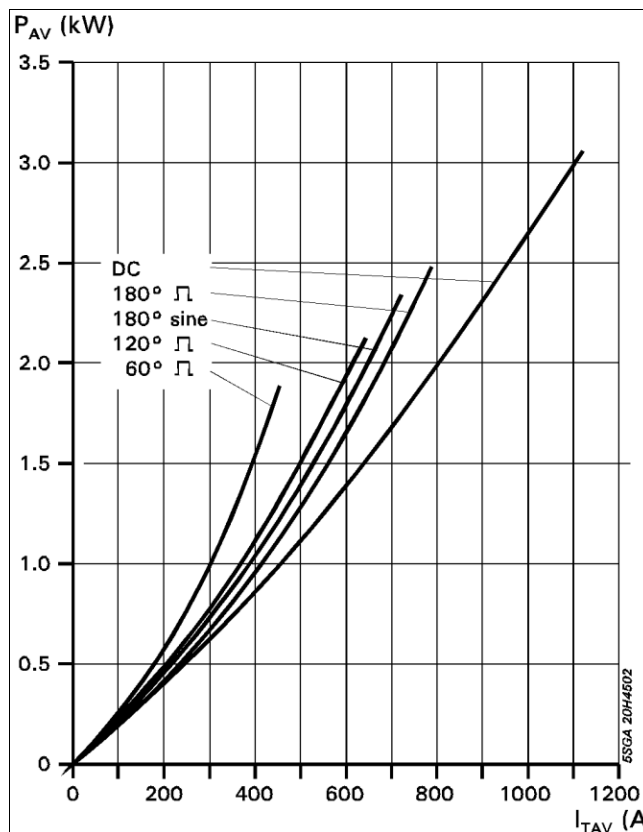


Fig. 3 Average on-state power dissipation vs. average on-state current.

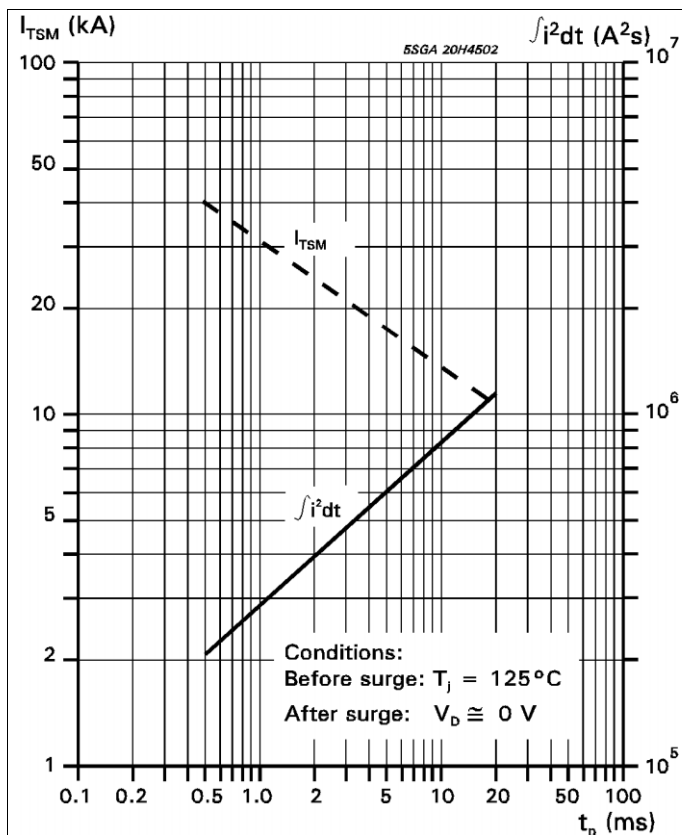


Fig. 4 Surge current and fusing integral vs. pulse width

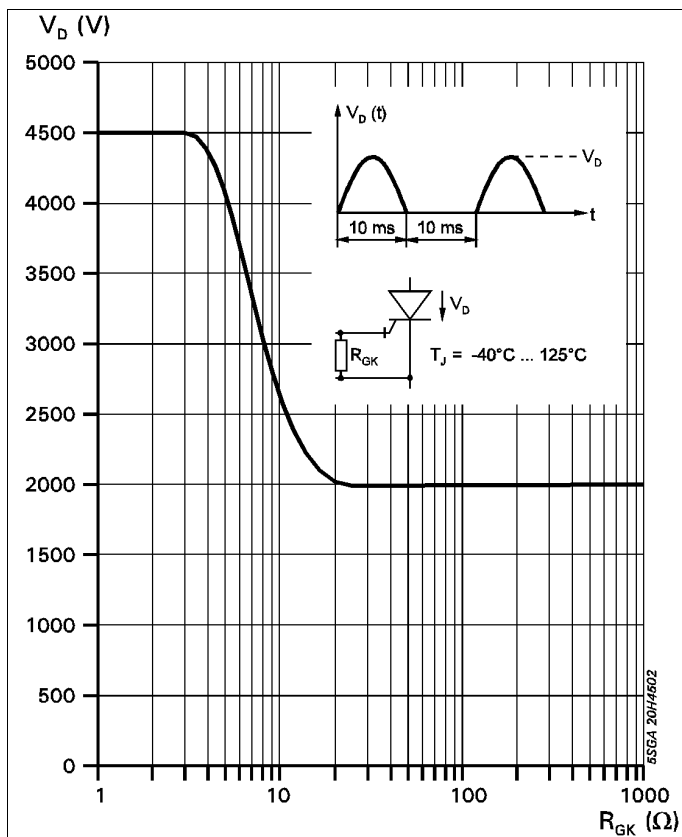


Fig. 5 Forward blocking voltage vs. gate-cathode resistance.

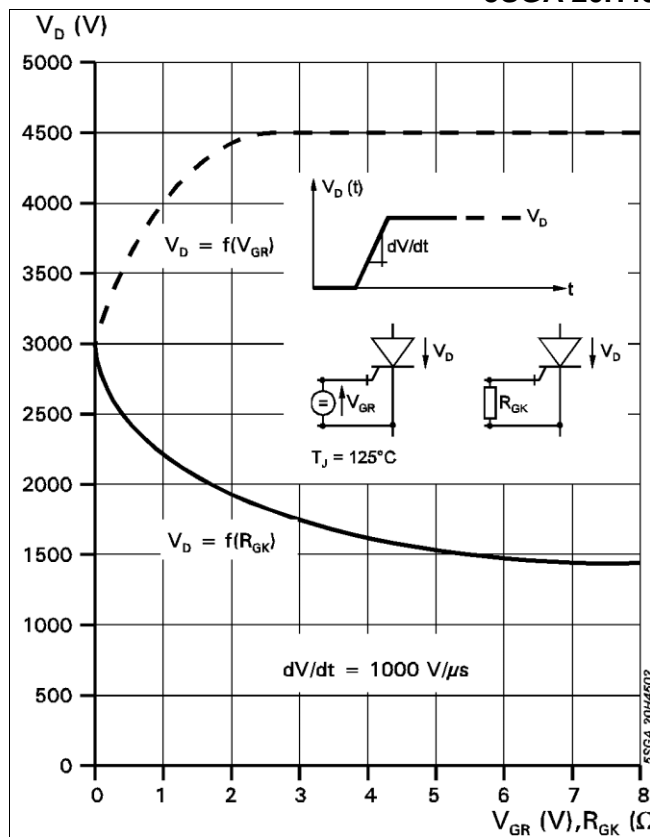


Fig. 6 Static dv/dt capability: Forward blocking voltage vs. neg. gate voltage or gate cathode resistance.

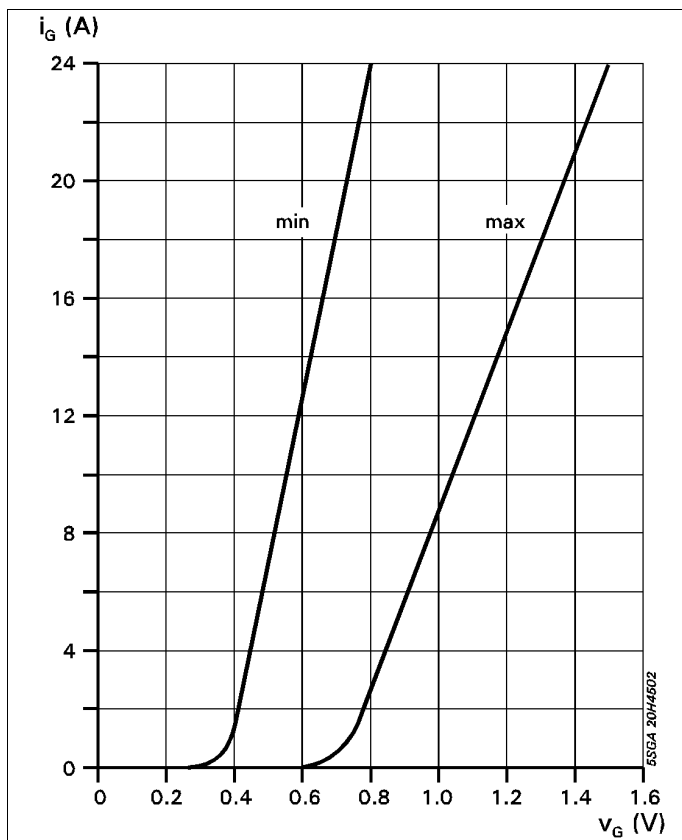


Fig. 7 Forward gate current vs. forward gate voltage.

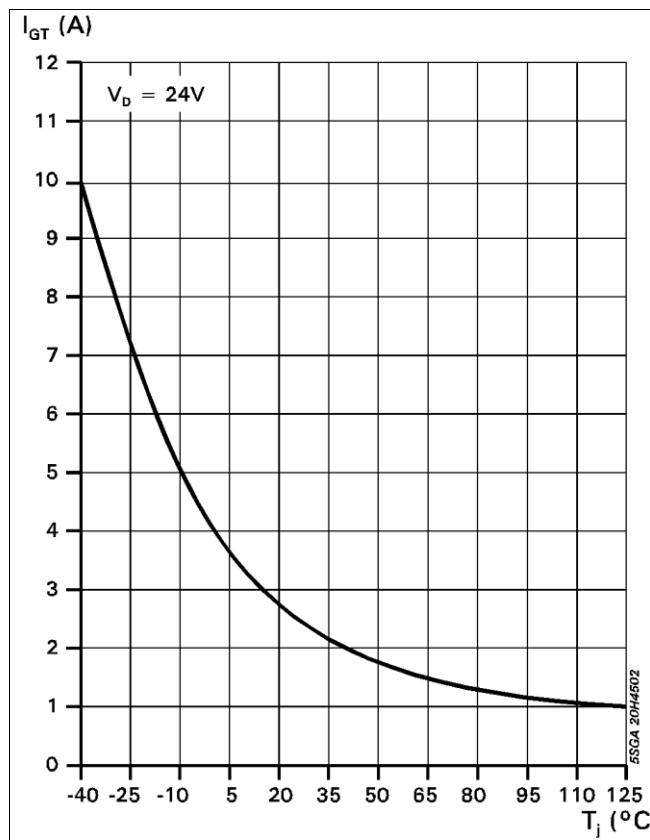


Fig. 8 Gate trigger current vs. junction temperature

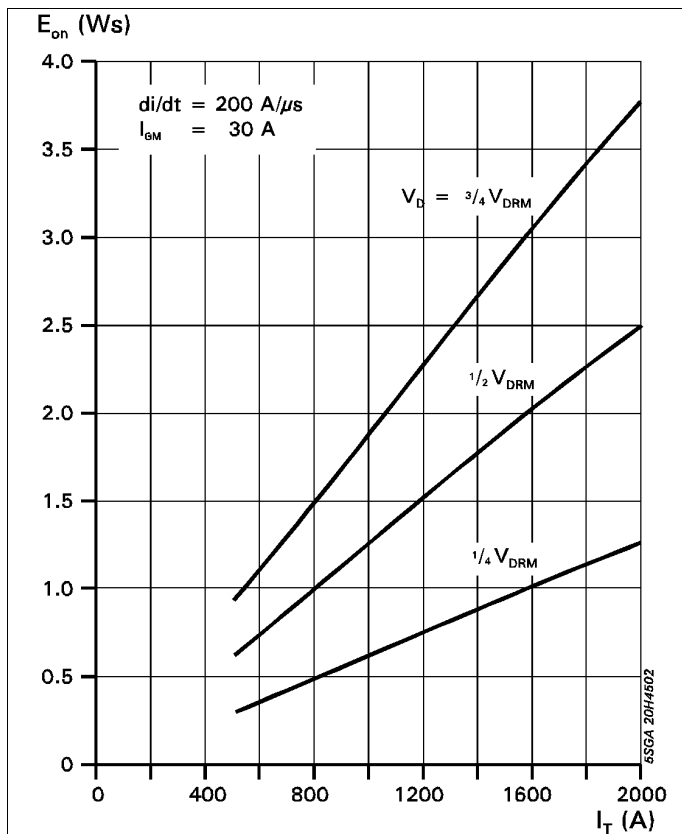


Fig. 9 Turn-on energy per pulse vs. on-state current and turn-on voltage.

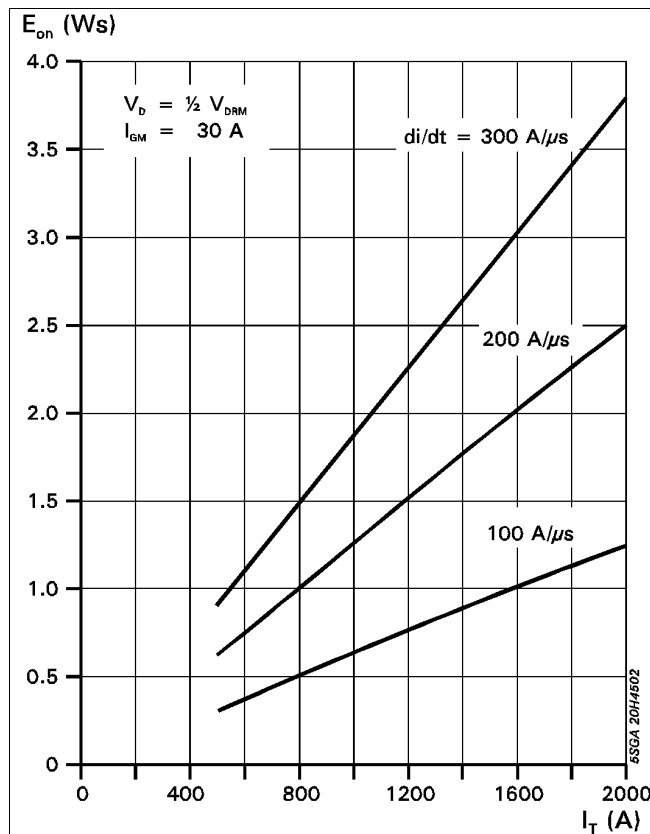


Fig. 10 Turn-on energy per pulse vs. on-state current and current rise rate

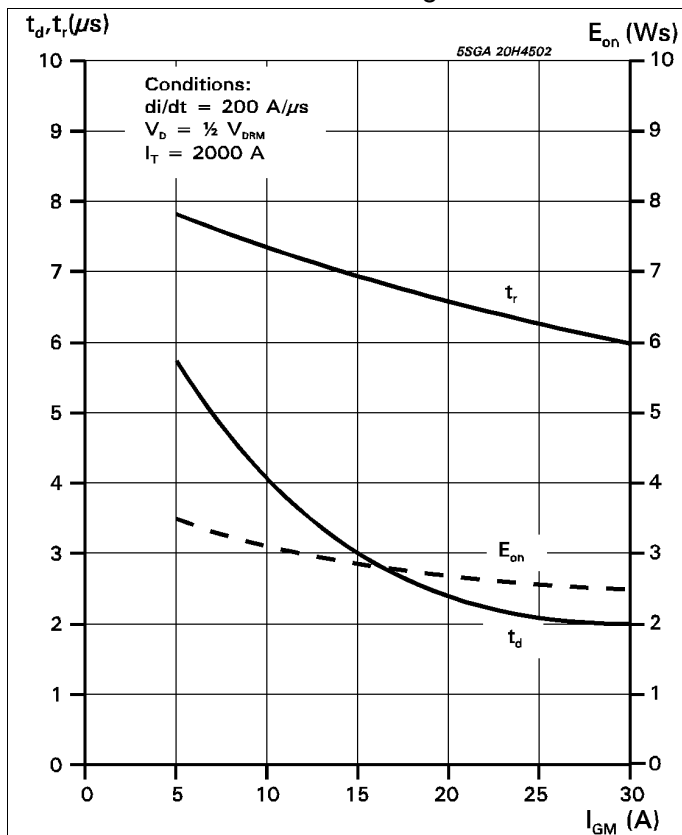


Fig. 11 Turn-on energy per pulse vs. on-state current and turn-on voltage.

Common Test conditions for figures 9, 10 and 11:

- $di_G/dt = 20 \text{ A}/\mu\text{s}$
- $C_S = 4 \mu\text{F}$
- $R_S = 5 \Omega$
- $T_J = 125 \text{ }^\circ\text{C}$

Definition of Turn-on energy:

$$E_{on} = \int_0^{20 \mu\text{s}} V_D \cdot I_T dt \quad (t = 0, I_G = 0.1 \cdot I_{GM})$$

Common Test conditions for figures 12, 13 and 15:

Definition of Turn-off energy:

$$E_{off} = \int_0^{40 \mu\text{s}} V_D \cdot I_T dt \quad (t = 0, I_T = 0.9 \cdot I_{TQ})$$

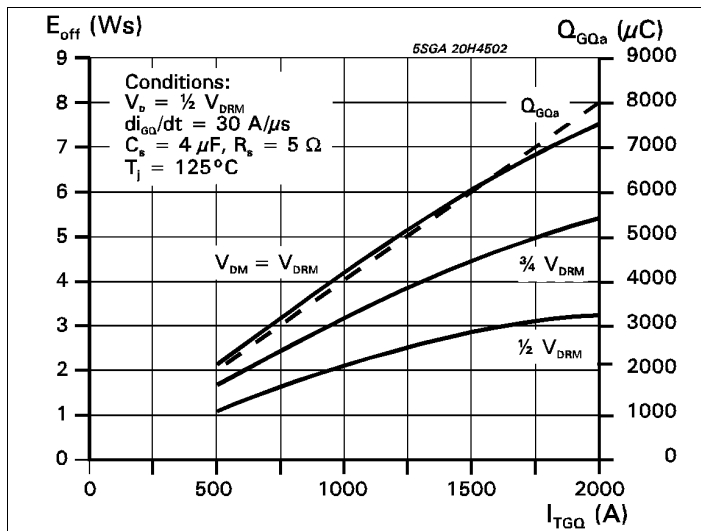


Fig. 12 Turn-off energy per pulse vs. turn-off current and peak turn-off voltage. Extracted gate charge vs. turn-off current.

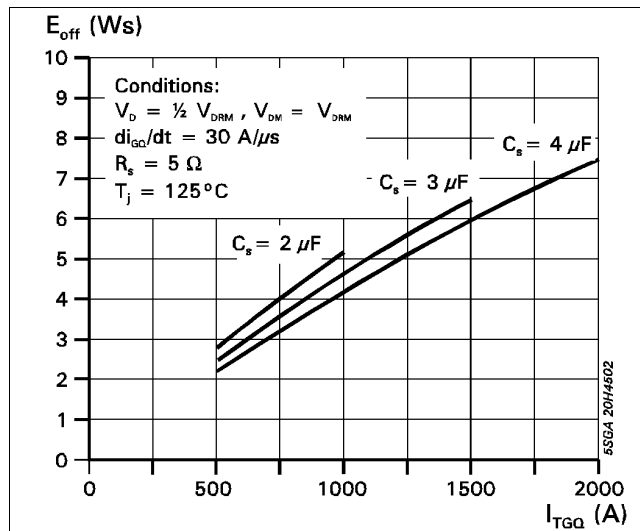


Fig. 13 Turn-off energy per pulse vs. turn-off current and snubber capacitance.

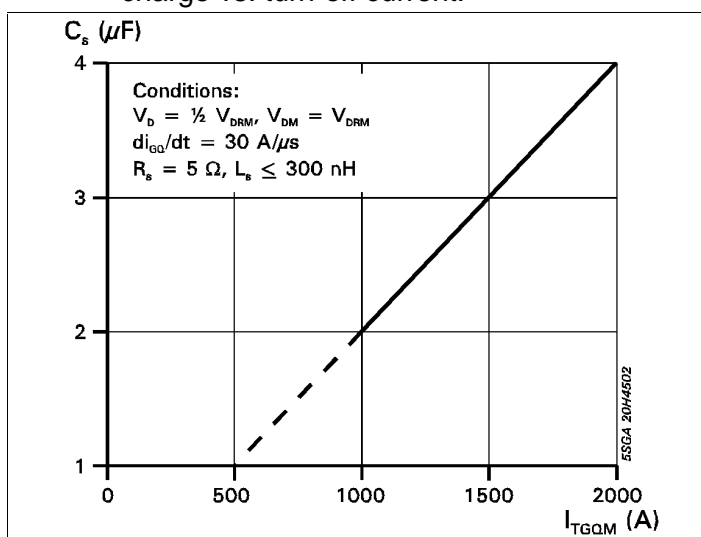


Fig. 14 Required snubber capacitor vs. max allowable turn-off current.

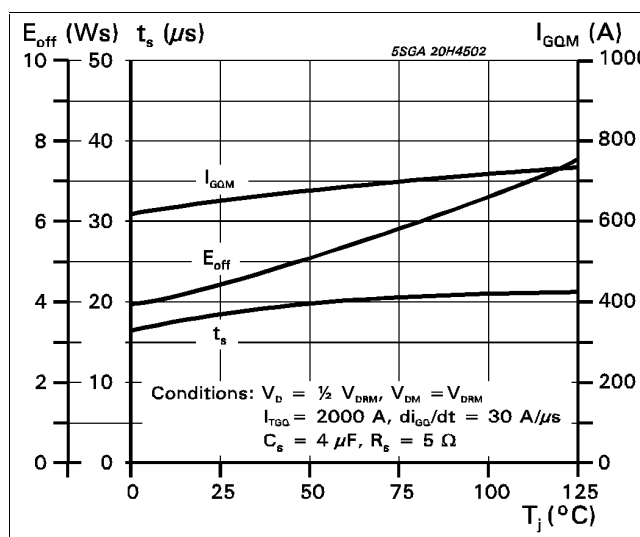


Fig. 15 Turn-off energy per pulse, storage time and peak turn-off gate current vs. junction temperature

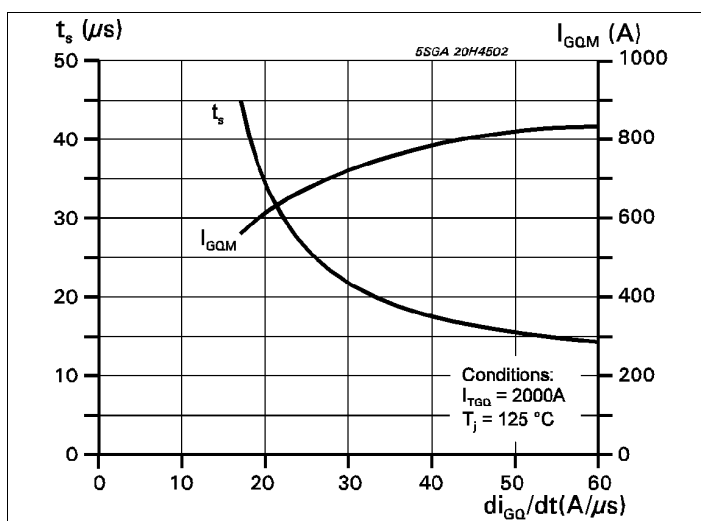


Fig. 16 Storage time and peak turn-off gate current vs. neg. gate current rise rate.

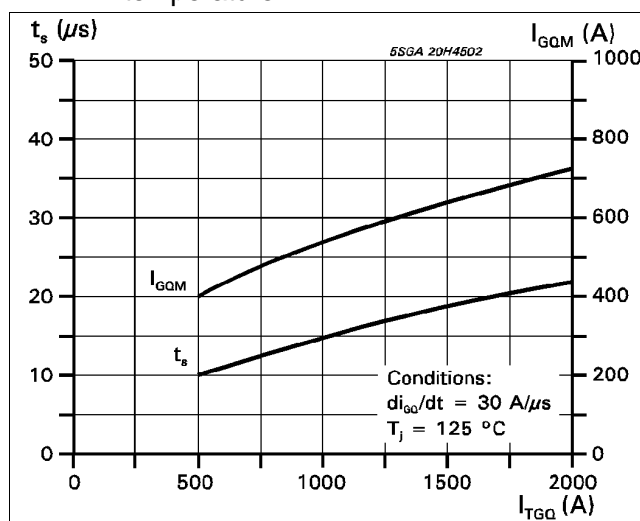


Fig. 17 Storage time and peak turn-off gate current vs. turn-off current

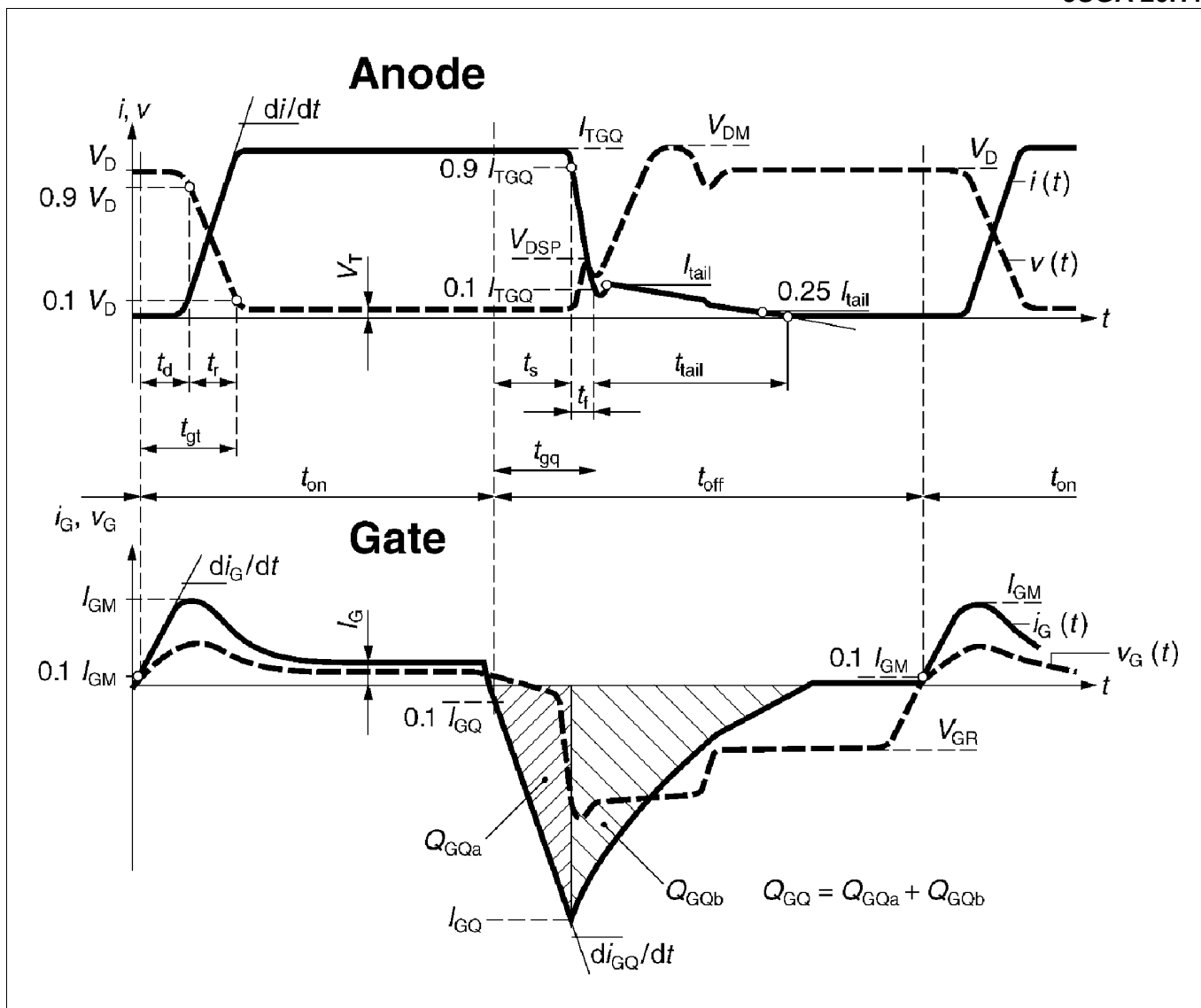


Fig. 18 General current and voltage waveforms with GTO-specific symbols

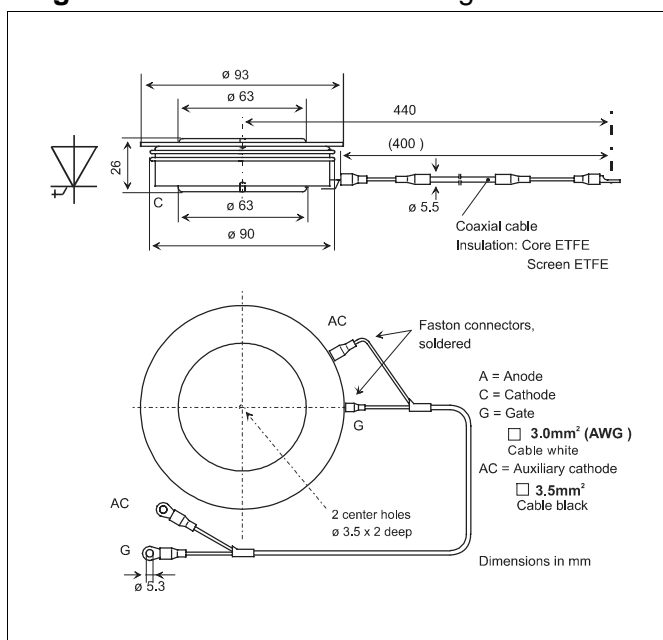


Fig. 19 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

Reverse avalanche capability

In operation with an antiparallel freewheeling diode, the GTO reverse voltage V_R may exceed the rated value V_{RRM} due to stray inductance and diode turn-on voltage spike at high di/dt . The GTO is then driven into reverse avalanche. This condition is not dangerous for the GTO provided avalanche time and current are below 10 μs and 1000 A respectively. However, gate voltage must remain negative during this time. Recommendation : $V_{GR} = 10 \dots 15$ V.

ABB Semiconductors AG reserves the right to change specifications without notice.

**ABB Semiconductors AG**

Fabrikstrasse 2
CH-5600 Lenzburg, Switzerland

Tel: +41 (0)62 888 6419
Fax: +41 (0)62 888 6306
E-mail info@ch.abb.com
Internet www.abbsem.com

Doc. No. 5SYA 1210-01 Aug. 2000